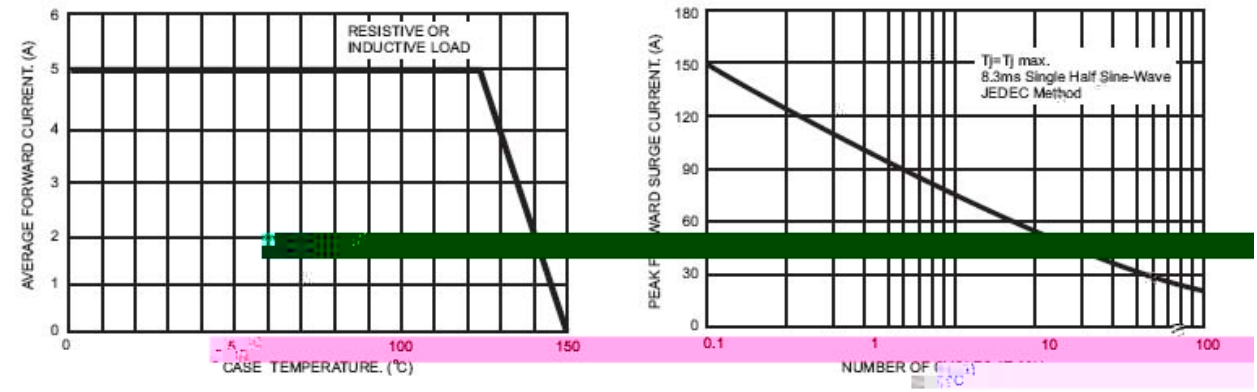
/ Absolute Maximum Ratings(Ta=25)

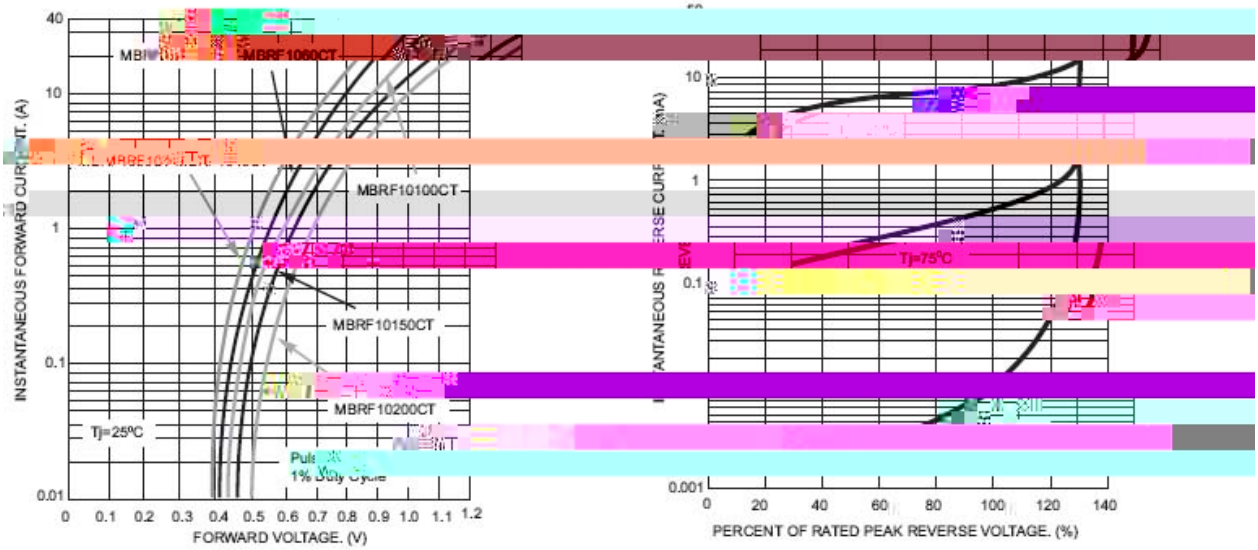
Parameter	Symbol	Rating	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	200	V
Average Forward Rectified Current	$I_{F(AV)}$	10	A
Peak Repetitive Forward Current	I_{FRM}	10	A
Peak Forward Surge Current	I_{FSM}	150	A
Peak Repetitive Reverse Surge Current	I_{RRM}	0.5	A
Typical Thermal Resistance Junction to Case	R_{Jc}	2.5	/W
Junction Temperature Range	T_j	150	
Storage Temperature Range	T_{stg}	-55 150	

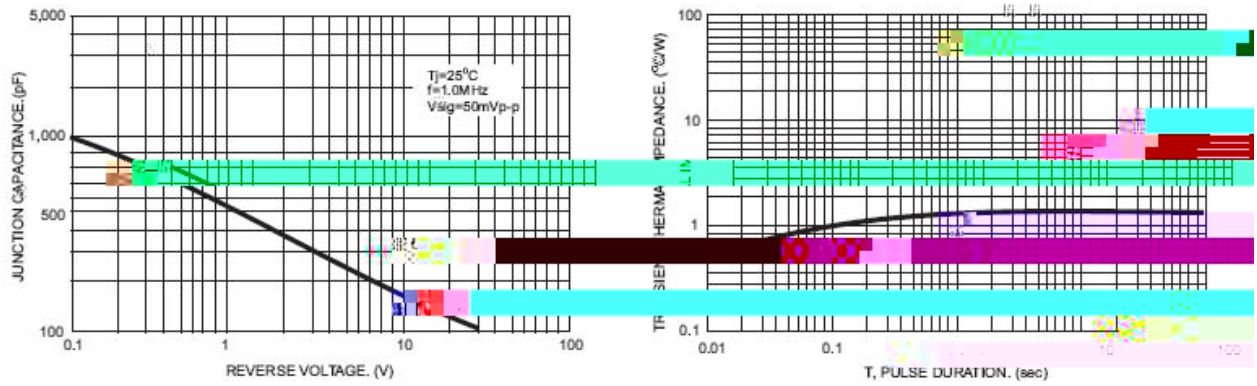
/ Electrical Characteristics(Ta=25)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Reverse Voltage	V_R		200			V
Forward Voltage	V_F	I_F=5.0A			0.99	V
		I_F=5.0A T_C=125			0.87	V
Instantaneous Reverse Current	I_{RM}	V_R=200V			0.15	mA
		V_R=200V T_c=125			150	mA
Voltage Rate of Change	dv/dt				10000	V/ s

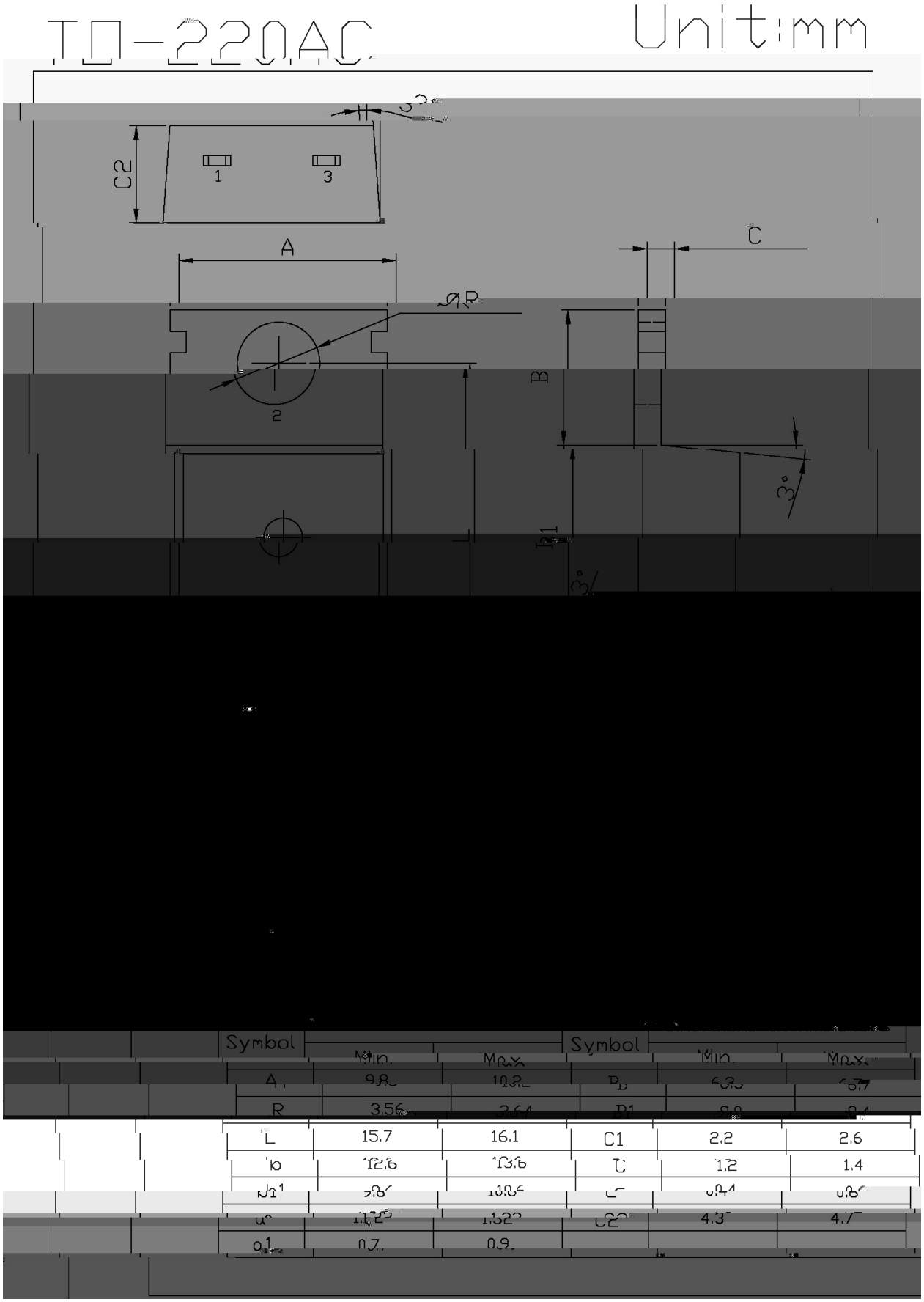
/ Electrical Characteristic Curve





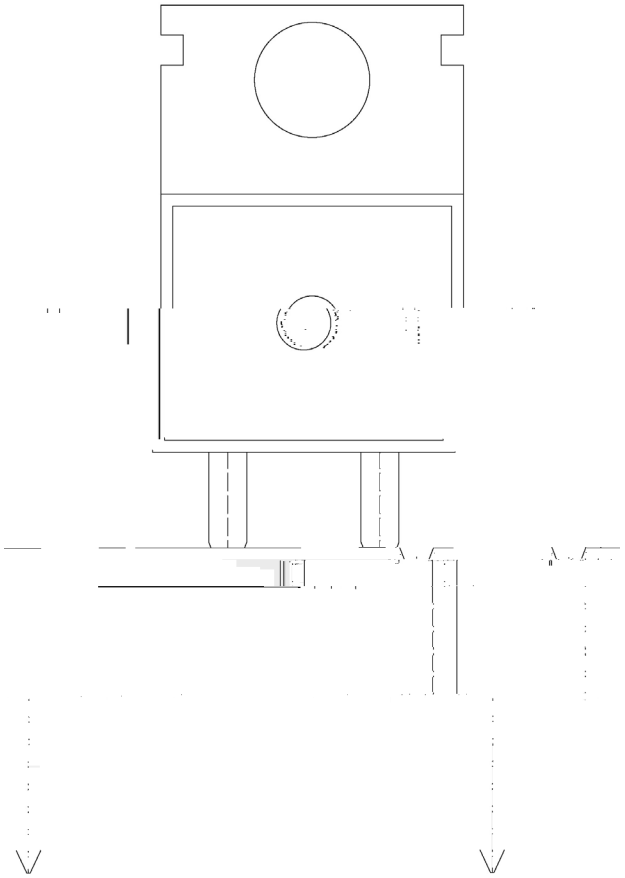


/ Package Dimensions



Symbol	Min.	Max.	Symbol	Min.	Max.
A	9.8	10.2	B_D	6.3	6.7
R	3.56	3.64	B1	8.0	8.4
L	15.7	16.1	C1	2.2	2.6
b	12.6	13.6	C	1.2	1.4
b1	1.26	1.36	c	0.44	0.6
e	2.42	2.62	e2	4.3	4.7
a1	0.7	0.9			

/ Marking Instructions



BR

MBR10200

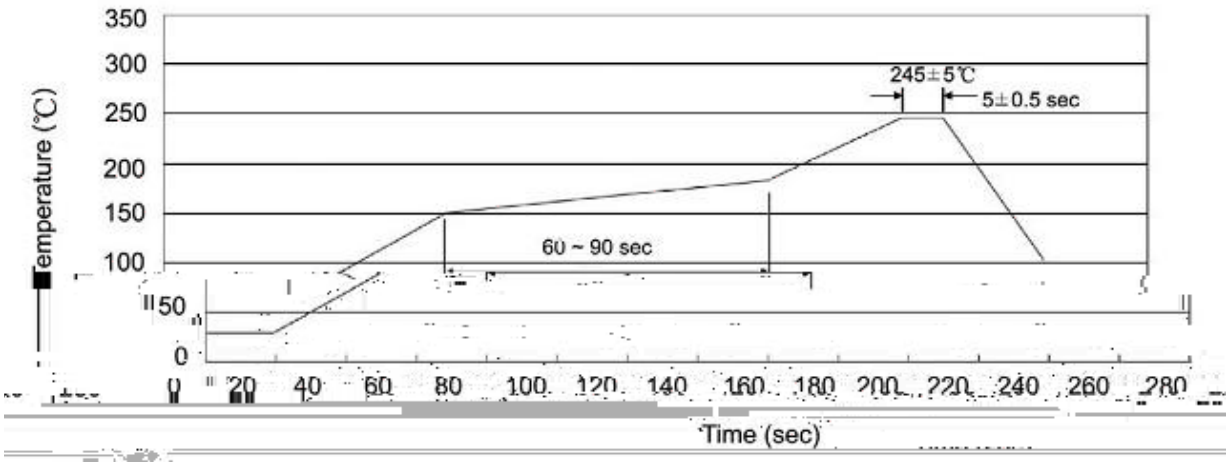
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Note:

BR: Company Code

MBR10200 ƒ 0 ⋆ Ḋ

( ) / Temperature Profile for Dip Soldering(Pb-Free)



		Note:	
1	150 180 60 90sec;	1.Preheating:150~180 , Time:60~90sec.	
2	255±5 5±0.5sec;	2.Peak Temp.:255±5 , Duration:5±0.5sec.	
3	2 10 /sec.	3. Cooling Speed: 2~10 /sec.	

/ Resistance to Soldering Heat Test Conditions

270±5	10±1 sec.	Temp.:270±5	Time:10±1 sec

/ Packaging SPEC.

/ BULK

Package Type	Units					Dimension		(unit mm^3)
	Units/Bag /	Bags/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Bag	Inner Box	Outer Box
TO-220/F/AC	200	10	2,000	5	10,000	135×190	237×172×102	560×245×195

/ TUBE

Package Type	Units					Dimension		(unit mm^3)
	Units/Tube /	Tubes/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Tube	Inner Box	Outer Box
TO-220/F/AC	50	20	1,000	5	5,000	532×31.4×5.5	555×164×50	575×290×180

/ Notices